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(54) Memory, writing apparatus, reading apparatus, writing method, and reading method

(57) A memory includes: first and second recording layers for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse. The crystallization temperatures of the first and second recording layers, T_{x1} and T_{x2}, have the relationship $T_{x1} < T_{x2}$. The crystallization times of the first and second recording layers, t_{x1} and t_{x2}, have the relationship $t_{x1} > t_{x2}$. $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}.

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Description

BACKGROUND OF THE INVENTION

1. FIELD OF THE INVENTION:

[0001] The present invention relates to a phase-change memory for storing information by utilizing a reversible phase change which may occur between a crystalline phase and an amorphous phase, a writing apparatus for writing information in the memory, a reading apparatus for reading information from the memory, and writing/reading methods therefor.

2. DESCRIPTION OF THE RELATED ART:

[0002] A phase-change memory in which information can be recorded or erased by applying electric energy such as an electric current is known. The material used as a recording layer of such a phase-change memory causes reversible change between the crystalline phase and the amorphous phase due to increases in temperature which results from the application of the electric energy. Generally, the electric resistance of the crystalline phase is low, whereas the electric resistance of the amorphous phase is high. The phase-change memory is a non-volatile memory in which binary information is recorded by utilizing the difference in electric resistance between the crystalline phase and the amorphous phase.

[0003] In recent years, along with the increase in amount of information to be recorded in a memory, a memory having a larger capacity has been demanded. In order to increase the capacity of a phase-change memory, two suggestions have been provided: (1) the area of a memory cell for recording a binary value is reduced, and a plurality of such memory cells are arranged in a matrix (increase in surface density); (2) information of a multi-value is stored in a single memory cell. In this specification, the "multi-value" does not include the "binary value".

[0004] Regarding suggestion (1), since there is a limit to a miniaturization process in a production technique such as photolithography, there is also a limit to the increase in surface density. Thus, it is impossible to drastically increase the capacity of a phase-change memory.

[0005] A known conventional technique for recording multi-value information in a single memory cell is disclosed in Japanese National Phase PCT Laid-Open Publication No. 11-510317. According to this conventional technique, the resistance value of a recording layer of a memory cell is controlled in a stepwise manner, whereby multi-value information can be stored in the memory cell. However, such a stepwise control of the phase state in a single recording layer involves greater difficulty rather than control of the phase state between the two phase states, i.e., the crystalline phase and the amorphous phase.

SUMMARY OF THE INVENTION

[0006] According to one aspect of the present invention, a memory includes: a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}.

[0007] In one embodiment of the present invention, the melting point of the first recording layer, T_{m1}, satisfies the relationship $400 \leq T_{m1}(°C) \leq 800$.

[0008] In another embodiment of the present invention, the melting point of the second recording layer, T_{m2}, satisfies the relationship $300 \leq T_{m2}(°C) \leq 700$.

[0009] In still another embodiment of the present invention, the crystallization temperature of the first recording layer, T_{x1}, satisfies the relationship $130 \leq T_{x1}(°C) \leq 230$.

[0010] In still another embodiment of the present invention, the crystallization temperature of the second recording layer, T_{x2}, satisfies the relationship $160 \leq T_{x2}(°C) \leq 260$.

[0011] In still another embodiment of the present invention, the crystallization time of the first recording layer, t_{x1},

satisfies the relationship $5 \leq t_{x1}(ns) \leq 200$.

[0012] In still another embodiment of the present invention, the crystallization time of the second recording layer, t_{x2}, satisfies the relationship $2 \leq t_{x2}(ns) \leq 150$.

[0013] In still another embodiment of the present invention, the first recording layer includes three elements, Ge, Sb, and Te; and the second recording layer includes (Sb-Te)-M1, where M1 is at least one selected from a group consisting of Ag, In, Ge, Sn, Se, Bi, Au, and Mn.

[0014] In still another embodiment of the present invention, the first recording layer is formed on a substrate, and the upper electrode is formed on the second recording layer.

[0015] In still another embodiment of the present invention, a lower electrode is formed between the substrate and the first recording layer.

[0016] In still another embodiment of the present invention, an intermediate layer is formed between the first recording layer and the second recording layer.

[0017] In still another embodiment of the present invention, the specific resistance r_{a1} of the first recording layer in the amorphous phase is $1.0 \leq r_{a1}(\Omega \cdot cm) \leq 1 \times 10^7$.

[0018] In still another embodiment of the present invention, the specific resistance r_{a2} of the second recording layer in the amorphous phase is $2.0 \leq r_{a2}(\Omega \cdot cm) \leq 2 \times 10^7$.

[0019] In still another embodiment of the present invention, the specific resistance r_{c1} of the first recording layer in the crystalline phase is $1 \times 10^{-3} \leq r_{c1}(\Omega \cdot cm) \leq 1.0$.

[0020] In still another embodiment of the present invention, the specific resistance r_{c2} of the second recording layer in the crystalline phase is $1 \times 10^{-3} \leq r_{c2}(\Omega \cdot cm) \leq 1.0$.

[0021] According to another aspect of the present invention, there is provided a writing apparatus for writing information in a memory, the memory including: a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and the writing apparatus including: a pulse generator for generating at least first to third electric current pulses; and an application section through which the at least first to third electric current pulses are applied to the first recording layer and the second recording layer, wherein in order to change the first recording layer from the amorphous phase to the crystalline phase while the phase state of the second recording layer is kept unchanged, the pulse generator generates the first electric current pulse which provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$, in order to change the second recording layer from the amorphous phase to the crystalline phase while the phase state of the first recording layer is kept unchanged, the pulse generator generates the second electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$, and in order to change both the first recording layer and the second recording layer from the crystalline phase to the amorphous phase, the pulse generator generates the third electric current pulse which provides a temperature equal to or higher than the higher one of the melting points of the first and second recording layers.

[0022] In one embodiment of the present invention, the pulse amplitude of the first electric current pulse, I_{c1}, is $0.02 \leq I_{c1}(mA) \leq 10$, and the pulse width of the first electric current pulse, t_{c1}, is $5 \leq t_{c1}(ns) \leq 200$.

[0023] In another embodiment of the present invention, the pulse amplitude of the second electric current pulse, I_{c2}, is $0.05 \leq I_{c2}(mA) \leq 20$, and the pulse width of the second electric current pulse, t_{c2}, is $2 \leq t_{c2}(ns) \leq 150$.

[0024] In still another embodiment of the present invention, the pulse amplitude of the third electric current pulse, I_{a1}, is $0.1 \leq I_{a1}(mA) \leq 200$, and the pulse width of the third electric current pulse, t_{a1}, is $1 \leq t_{a1}(ns) \leq 100$.

[0025] In still another embodiment of the present invention, in order to change both the first recording layer and the second recording layer from the amorphous phase to the crystalline phase, the pulse generator generates a fourth electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x1} \leq t$.

[0026] In still another embodiment of the present invention, the pulse amplitude of the fourth electric current pulse, I_{c12}, is $0.05 \leq I_{c12}(mA) \leq 20$, and the pulse width of the fourth electric current pulse, t_{c12}, is $5 \leq t_{c12}(ns) \leq 200$.

[0027] In still another embodiment of the present invention, when the melting point of the first recording layer, T_{m1}, and the melting point of the second recording layer, T_{m2}, have the relationship $T_{m1} \neq T_{m2}$, in order to change the recording layer having the lower one of the melting points T_{m1} and T_{m2} from the crystalline phase to the amorphous phase while the phase state of the recording layer having the higher one of the melting points T_{m1} and T_{m2} is kept at the crystalline

phase, the pulse generator generates a fifth electric current pulse which provides a temperature equal to or higher than the lower one of the melting points T_{m1} and T_{m2} and lower then the higher one of the melting points T_{m1} and T_{m2}.

[0028] In still another embodiment of the present invention, the pulse amplitude of the fifth electric current pulse, I_{a2}, is $0.05 \leq I_{a2}(mA) \leq 160$, and the pulse width of the fifth electric current pulse, t_{p2}, is $1 \leq t_{p2}(ns) \leq 100$.

[0029] According to still another aspect of the present invention, there is provided a reading apparatus for reading information from a memory, the memory including: a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and the reading apparatus including: an application section through which an electric current pulse is applied to the first and second recording layers; a resistance measurement device for measuring a sum of the resistances of the first and second recording layers; and a determination section for determining which of the four different sums of resistance values, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$, the measured sum of the resistance values of the first and second recording layers is equal to.

[0030] In one embodiment of the present invention, the electric current pulse has an amplitude I_r having a size such that a phase change is not caused in the first and second recording layers.

[0031] In another embodiment of the present invention, the amplitude I_r of the electric current pulse is $I_r(mA) \leq 0.02$.

[0032] According to still another aspect of the present invention, a memory includes N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$, the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values.

[0033] According to still another aspect of the present invention, there is provided a writing apparatus for writing information in a memory, the memory including N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$, the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and the writing apparatus including: a pulse generator for generating at least N crystallization pulses and amorphization pulse, and an application section through which the at least N crystallization pulses and amorphization pulse are applied to the N recording layers, wherein in order to change only the m-th recording layer from the amorphous phase to the crystalline phase while the phase states of the other recording layers are kept unchanged, the pulse generator generates a crystallization pulse which provides a temperature (T) that satisfies $T_{xm} \leq T_x < T_{x(m+1)}$ during a time (t) that satisfies $t_{xm} \leq t_x < t_{x(m-1)}$, and in order to change all of the N recording layers from the crystalline phase to the amorphous phase, the pulse generator generates the amorphization pulse which provides a temperature equal to or higher than the highest one of the melting points of the N recording layers.

[0034] In one embodiment of the present invention, in order to change all of the N recording layers from the amorphous phase to the crystalline phase, the pulse generator generates an electric current pulse which provides a temperature (T) that satisfies $T_{xN} \leq T_x$ during a time (t) that satisfies $t_{x1} \leq t_x$.

[0035] In another embodiment of the present invention, in order to change the m-th to (m+n-1)th recording layers among the N recording layers from the amorphous phase to the crystalline phase, the pulse generator generates an electric current pulse which provides a temperature (T) that satisfies $T_{x(m+n-1)} \leq T_x < T_{x(m+n)}$ during a time (t) that satisfies $t_{xm} \leq t_x < t_{x(m-1)}$.

[0036] In another embodiment of the present invention, when each of one or more recording layers among the N recording layers has a melting point equal to or lower than a temperature T_m, and each of the other recording layers

among the N recording layers has a melting point higher than the temperature T_m, in order to change the one or more recording layers from the crystalline phase to the amorphous phase while the other recording layers are kept at the crystalline phase, the pulse generator generates an electric current pulse which produces the temperature T_m.

[0037] According to still'another aspect of the present invention, there is provided a reading apparatus for reading information from a memory, the memory including N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$, the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and the reading apparatus including: an application section through which an electric current pulse is applied to the N recording layers; a resistance measurement device for measuring a sum of the resistances of the N recording layers; and a determination section for determining which of the 2^N different values for the sum of resistance values the measured sum of the resistance values of the N recording layers is equal to.

[0038] According to still another aspect of the present invention, there is provided a method for writing information in a memory, the memory including: a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and the writing method including steps of: generating at least first to third electric current pulses; and applying the at least first to third electric current pulses to the first recording layer and the second recording layer, wherein, in the step of generating the at least first to third electric current pulses, in order to change the first recording layer from the amorphous phase to the crystalline phase while the phase state of the second recording layer is kept unchanged, the pulse generator generates the first electric current pulse which provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$, in order to change the second recording layer from the amorphous phase to the crystalline phase while the phase state of the first recording layer is kept unchanged, the pulse generator generates the second electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$, and in order to change both the first recording layer and the second recording layer from the crystalline phase to the amorphous phase, the pulse generator generates the third electric current pulse which provides a temperature equal to or higher than the higher one of the melting points of the first and second recording layers.

[0039] According to still another aspect of the present invention, there is provided a method for reading information from a memory, the memory including: a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and the reading method including steps of: applying an electric current pulse to the first recording layer and the second recording layer; measuring a sum of the resistances of the first and second recording layers; and determining which of the four different sums of resistance values, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$, the measured sum of the resistance values of the first and second recording layers is equal to.

[0040] According to still another aspect of the present invention, there is provided a method for writing information in a memory, the memory including N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs

due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \le m \le N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$, the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and the writing method including steps of: generating at least N crystallization pulses and amorphization pulse, and applying the at least N crystallization pulses and amorphization pulse to the N recording layers, wherein, in the step of generating the first to (N+1)th electric current pulses, in order to change only the m-th recording layer from the amorphous phase to the crystalline phase while the phase states of the other recording layers are kept unchanged, the pulse generator generates a crystallization pulse which provides a temperature (T) that satisfies $T_{xm} \le T_x < T_{x(m+1)}$ during a time (t) that satisfies $t_{xm} \le t_x < t_{x(m-1)}$, and in order to change all of the N recording layers from the crystalline phase to the amorphous phase, the pulse generator generates the amorphization pulse which provides a temperature equal to or higher than the highest one of the melting points of the N recording layers.

[0041] According to still another aspect of the present invention, there is provided a method for reading information from a memory, the memory including N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse, wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \le m \le N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$, the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and the reading method including steps of: applying an electric current pulse to the N recording layers; measuring a sum of the resistances of the N recording layers; and determining which of the 2^N different values for the sum of resistance values the measured sum of the resistance values of the N recording layers is equal to.

[0042] Thus, the invention described herein makes possible the advantages of providing: a phase-change memory which stores multi-value information and in which writing and reading of information can be readily performed; a writing apparatus for writing information in such a phase-change memory; a reading apparatus for reading information from such a phase-change memory; and writing and reading methods employed in conjunction with such a phase-change memory.

[0043] These and other advantages of the present invention will become apparent to those skilled in the art upon reading and understanding the following detailed description with reference to the accompanying figures.

BRIEF DESCRIPTION OF THE DRAWINGS

[0044]

Figure **1** shows a structure of a writing/reading apparatus connected to a memory according to the present invention.

Figure **2** illustrates transition of the state of the memory based on the phase states of first and second recording layers.

Figure **3** shows the waveforms of electric current pulses employed to change the phase states of the two recording layers.

Figure **4** is a flowchart illustrating the method for reading information from the memory by using the writing/reading apparatus of the present invention.

Figure **5** shows an exemplary structure formed by a storage device including a plurality of memories of the present invention arranged in a matrix and an external circuit connected to the storage device.

Figure **6** shows a memory including N recording layers.

Figure **7** shows the waveforms of electric current pulses employed to change the phase states of the N recording layers.

Figure **8** is a flowchart illustrating the method for reading information from the memory by using the writing/reading apparatus of the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0045] Hereinafter, embodiments of the present invention will be described with reference to the drawings.

(Embodiment 1)

[0046] Figure **1** shows a structure of a writing/reading apparatus connected to a memory according to the present invention. The writing/reading apparatus **12** writes information in the memory **11** or reads information from the memory **11.**

[0047] The writing/reading apparatus **12** includes a pulse generator **7** for generating an electric current pulse, a resistance measurement section **8** for measuring the resistance of the memory **11**, switches **9** and **10**, application sections **13** for applying an electric current pulse generated by the pulse generator **7** to the memory **11**, and a determination section **16** for determining the resistance value of the memory **11** measured by the resistance measurement section **8.**

[0048] The memory **11** includes a substrate **1,** a lower electrode **2** formed over the substrate **1,** a first recording layer **3** formed over the lower electrode **2,** an intermediate layer **4** formed over the first recording layer **3,** a second recording layer **5** formed over the intermediate layer **4,** and an upper electrode **6** formed over the second recording layer **5.**

[0049] For example, as the substrate **1,** a resin plate of polycarbonate or the like, a glass plate, a ceramic plate of alumina (Al_2O_3) or the like, an Si plate, metal plates of Cu or the like, etc., may be used, but the present invention is not limited to these examples. In embodiment **1,** an Si substrate is used as the substrate **1.** As the lower electrode **2** and the upper electrode **6,** for example, a single metal material, such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or a combination thereof (alloy material) may be used. However, according to the present invention, any electrode material may be used so long as electric energy can be applied to the first recording layer **3** and the second recording layer **5** through the electrodes **2** and **6.** The intermediate layer **4** is provided for preventing atoms which constitute one of the first recording layer **3** and the second recording layer **5** from diffusively moving therebetween. The intermediate layer **4** is preferably electrically conductive and may be made of a single metal material, such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or a combination thereof (alloy material). However, the material of the intermediate layer **4** is not limited to these materials. In embodiment 1, Pt is used in the lower electrode **2,** the intermediate layer **4,** and the upper electrode **6.**

[0050] It should be noted that any structure for applying an electric current pulse to the first recording layer **3** and the second recording layer **5** can be employed in place of the lower electrode **2** and/or the upper electrode **6.** For example, if the substrate **1** is electrically conductive, the lower electrode **2** can be omitted. Furthermore, the intermediate layer **4** may be omitted when the first recording layer **3** and the second recording layer **5** are made of such a material that atoms constituting the recording layers **3** and **5** do not diffusively moves therebetween.

[0051] Furthermore, the first recording layer **3** and the second recording layer **5** are made of such a material that a reversible phase change between the crystalline phase and the amorphous phase is caused by increases in temperature due to application of electric energy such as an electric pulse or the like. The material of the first recording layer **3** and the second recording layer **5** is selected such that the following conditions **1**-3 are satisfied:

Condition 1: The crystallization temperature of the first recording layer **3,** T_{x1}, and the crystallization temperature of the second recording layer **5,** T_{x2}, satisfy the relationship $T_{x1} < T_{x2}$. In this specification, "crystallization temperature" means a temperature at which the material of a recording layer changes from the amorphous phase to the crystalline phase.

Condition 2: The crystallization time of the first recording layer **3**, t_{x1}, and the crystallization time of the second recording layer **5**, t_{x2}, satisfy the relationship $t_{x1} > t_{x2}$. In this specification, "crystallization time" means a time spent during which the material of a recording layer changes from the amorphous phase to the crystalline phase.

Condition 3: Where the resistance value of the first recording layer **3** in the amorphous phase is R_{a1}, the resistance value of the first recording layer **3** in the crystalline phase is R_{c1}, the resistance value of the second recording layer **5** in the amorphous phase is R_{a2}, and the resistance value of the second recording layer **5** in the crystalline phase is R_{c2}, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another.

[0052] By satisfying Condition **1** and Condition 2, the phase state of the first recording layer **3** and the phase state of the second recording layer **5** each can be set to a desired state (amorphous phase or crystalline phase). Moreover, by satisfying Condition 3, four states represented by combinations of the phase state of the first recording layer **3** and

the phase state of the second recording layer **5** can be distinguishably detected. Thus, the first recording layer **3** and the second recording layer 5 of the memory **11** can store 4-value information (2 bits) corresponding to the four states. In this structure, the phase state of each recording layer is controlled between the crystalline phase and the amorphous phase. This is easier than a stepwise control of the phase state of a single recording layer.

[0053] The crystallization temperature T_{x1} of the first recording layer **3** is preferably $130 \leq T_{x1}$ (°C) ≤ 230. The crystallization temperature T_{x2} of the second recording layer **5** is preferably $160 \leq T_{x2}$(°C) ≤ 260. The crystallization time t_{x1} of the first recording layer **3** is preferably $5 \leq t_{x1}$(ns) ≤ 200. The crystallization time t_{x2} of the second recording layer **5** is preferably $2 \leq t_{x2}$(ns) ≤ 150.

[0054] The specific resistance r_{a1} of the first recording layer **3** in the amorphous phase is preferably $1.0 \leq r_{a1}(\Omega \cdot \text{cm}) \leq 1\times10^{7}$. The specific resistance r_{a2} of the second recording layer **5** in the amorphous phase is preferably $2.0 \leq r_{a2}(\Omega \cdot \text{cm}) \leq 2\times10^{7}$. The specific resistance r_{c1} of the first recording layer **3** in the crystalline phase is preferably $1\times10^{-3} \leq r_{c1}(\Omega \cdot \text{cm}) \leq 1.0$. The specific resistance r_{c2} of the second recording layer **5** in the crystalline phase is preferably $1\times10^{-3} \leq r_{c2}(\Omega \cdot \text{cm}) \leq 1.0$.

[0055] In embodiment 1, the melting point of the first recording layer **3**, T_{m1}, and the melting point of the second recording layer **5**, T_{m2}, have the relationship $T_{m1} > T_{m2}$. However, according to the present invention, these melting points T_{m1} and T_{m2} may have any relationship. In embodiment 1, the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** are 630°C and 550°C, respectively. According to the present invention, the melting point T_{m1} of the first recording layer **3** is preferably $400 \leq T_{m1}$(°C) ≤ 800, and the melting point T_{m2} of the second recording layer **5** is preferably $300 \leq T_{m2}$(°C) ≤ 700.

[0056] The first recording layer **3** includes three elements, Ge, Sb, and Te. The second recording layer **5** includes a material system represented by (Sb-Te)-M1 where M1 is at least one selected from a group consisting of Ag, In, Ge, Sn, Se, Bi, Au, andMn. In embodiment 1, the first recording layer **3** and the second recording layer **5** are $Ge_8Sb_2Te_{11}$ and $(Sb_{0.7}Te_{0.3})_{85}Ge_5$, respectively.

[0057] In embodiment 1, the crystallization temperature T_{x1} of the first recording layer **3** and the crystallization temperature T_{x2} of the second recording layer **5** are 170°C and 200°C, respectively. The crystallization time t_{x1} of the first recording layer **3** and the crystallization time t_{x2} of the second recording layer **5** are 130 ns and 80 ns, respectively.

[0058] Further, in embodiment 1, the lower electrode **2** of Pt has an area of 10 μm × 10 μm and a thickness of 0.1 μm. The first recording layer **3** of $Ge_8Sb_2Te_{11}$ has an area of 5 μm × 5 μm and a thickness of 0.1 μm. The intermediate layer **4** of Pt has an area of 5 μm × 5 μm and a thickness of 0.1 μm. The second recording layer **5** of $(Sb_{0.7}Te_{0.3})_{85}Ge_5$ has an area of 5 μm × 5 μm and a thickness of 0.1 μm. The upper electrode **6** of Pt has an area of 5 μm × 5 μm and a thickness of 0.1 μm. In this structure, the resistance value R_{a1} of the first recording layer **3** in the amorphous phase and the resistance value R_{a2} of the second recording layer **5** in the amorphous phase are 1000 Ω and 1500 Ω, respectively. The resistance value R_{c1} of the first recording layer **3** in the crystalline phase and the resistance value R_{c2} of the second recording layer **5** in the crystalline phase are 5 Ω and 10 Ω, respectively.

[0059] The memory **11** has four different states shown in Table 1 below, State 1 to State 4. States 1-4 are represented by combinations of the phase states of the first recording layer **3** and the second recording layer **5** (amorphous phase and crystalline phase). Table 1 shows the phase states of the first recording layer **3** and the second recording layer **5** and the sum of the resistance values of the recording layers **3** and **5** for each of States 1-**4** of the memory **11**.

[Table 1]

State of Memory 11	1st recording layer 3	2nd recording layer 5	Sum of resistances
State 1	Amorphous	Amorphous	$R_{a1} + R_{a2}$ (≈2500 Ω)
State 2	Crystal	Amorphous	$R_{c1} + R_{a2}$ (≈1505 Ω)
State 3	Amorphous	Crystal	$R_{a1} + R_{c2}$ (≈1010 Ω)
State 4	Crystal	Crystal	$R_{c1} + R_{c2}$ (≈15 Ω)

When the first recording layer **3** and the second recording layer **5** are both in the amorphous phase (State 1), the sum of the resistance of the first recording layer **3** and the resistance of the second recording layer 5 is $R_{a1}+R_{a2}$. When the first recording layer **3** is in the crystalline phase and the second recording layer **5** is in the amorphous phase (State 2), the sum of the resistance of the first recording layer **3** and the resistance of the second recording layer **5** is $R_{c1}+R_{a2}$. When the first recording layer **3** is in the amorphous phase and the second recording layer **5** is in the crystalline phase (State 3), the sum of the resistance of the first recording layer **3** and the resistance of the second recording layer **5** is $R_{a1}+R_{c2}$. When the first recording layer **3** and the second recording layer **5** are both in the crystalline phase (State 4), the sum of the resistance of the first recording layer **3** and the resistance of the second recording layer **5** is $R_{c1}+R_{c2}$. As described above, the sum of the resistances of the recording layers **3** and **5** is different among the States 1-4.

[0060] Next, a procedure for producing the memory **11** (steps S1101 to S1106) is described:

S1101: The substrate **1** is subjected to a surface treatment and then introduced into a sputtering apparatus.

S1102: A single metal target such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or an alloy metal target of these metals is sputtered in an Ar gas atmosphere so as to form the lower electrode **2**.

S1103: An alloy target including three elements, Ge, Sb, and Te, is sputtered in an atmosphere selected from a group consisting of an Ar gas atmosphere, a Kr gas atmosphere, a mixed gas atmosphere formed by Ar gas and reactive gas including at least one of oxygen gas and nitrogen gas, and a mixed gas atmosphere formed by Kr gas and reactive gas, so as to form the first recording layer **3** on the lower electrode **2**.

S1104: A single metal target such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or an alloy metal target of these metals is sputtered in an Ar gas atmosphere so as to form the intermediate layer **4** on the first recording layer **3**.

S1105: An alloy target including a material system represented by (Sb-Te)-M1 (where M1 is at least one selected from a group consisting of Ag, In, Ge, Sn, Se, Bi, Au, and Mn) is sputtered in an atmosphere selected from a group consisting of an Ar gas atmosphere, a Kr gas atmosphere, a mixed gas atmosphere formed by Ar gas and reactive gas including at least one of oxygen gas and nitrogen gas, and a mixed gas atmosphere formed by Kr gas and reactive gas, so as to form the second recording layer **5** on the intermediate layer **4**.

S1106: A single metal target such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or an alloy metal target of these metals is sputtered in an Ar gas atmosphere so as to form the upper electrode **6** on the second recording layer **5**.

[0061] In the production steps S1101 to S1106, the sputtering apparatus is used to form the lower electrode **2**, the first recording layer **3**, the intermediate layer **4**, the second recording layer **5**, and the upper electrode **6**. However, according to the present invention, any thin film forming apparatus can be used to form these layers. In embodiment 1, at step S1101, the surface of the Si substrate **1** is nitrided in a nitride atmosphere. In the thus-produced memory **11**, an Au lead wire is bonded to each of the lower electrode **2** and the upper electrode **6**. The Au lead wires are connected to the reading/writing apparatus **12** through the application sections **13**.

[0062] Next, a method for writing information in the memory **11** and a method for erasing information from the memory **11** are described. When writing information in or erasing information from the memory **11**, the switch **9** is closed and the switch **10** is opened. The pulse generator **7** generates an electric current pulse having an amplitude and width which are required to change the phase states of the first recording layer **3** and the second recording layer **5** to desired phase states. The electric current pulse generated by the pulse generator **7** is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13**.

[0063] Figure **2** illustrates the transition of the state of the memory **11** based on the phase states of the first recording layer **3** and the second recording layer **5**.

[0064] In embodiment **1**, referring to Table 1 in conjunction with Figure **2**, an operation which causes a transition from State 1 to State 2, an operation which causes a transition from State 1 to State 3, an operation which causes a transition from State 1 to State 4, an operation which causes a transition from State 2 to State 3, an operation which causes a transition from State 2 to State 4, an operation which causes a transition from State 3 to State 2, an operation which causes a transition from State 3 to State 4, an operation which causes a transition from State 4 to State 2, an operation which causes a transition from State 4 to State 3 are referred to as "write" operations. On the other hand, an operation which causes a transition from State 2 to State 1, an operation which causes a transition from State 3 to State 1, an operation which causes a transition from State 4 to State 1, are referred to as "erase" operations. The phase states of the first recording layer **3** and the second recording layer **5** are changed to desired phase states, whereby information can be written in the memory **11** or information can be erased from the memory **11**.

[0065] Hereinafter, steps of writing information in and/or erasing information from the memory **11** are described with reference to Figure **2**:

Step S1: When State 1 is changed to State 2 or when State 3 is changed to State 4, i.e., when the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the phase state of the second recording layer **5** is kept unchanged, the pulse generator **7** (Figure **1**) generates a first electric current pulse, which is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13** (Figure 1). The first electric current pulse provides a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} < t$. Specific waveforms of the electric current pulse are described later with reference to Figure **3**.

Step S2: When State 1 is changed to State 3 or when State 2 is changed to State 4, i.e., when the phase state of the first recording layer **3** is kept unchanged while the second recording layer **5** is changed from the amorphous phase to the crystalline phase, the pulse generator **7** generates a second electric current pulse, which is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13**. The second electric current pulse provides a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$.

Step S3: When State **4** is changed to State 1, i.e., when the first recording layer **3** and the second recording layer **5** are both changed from the crystalline phase to the amorphous phase, the pulse generator **7** generates a third electric current pulse, which is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13**. The third electric current pulse provides a temperature which Is equal to or higher than the higher one of the melting points of the recording layers **3** and **5.**

Step S4: When State 1 is changed to State **4**, i.e., when the first recording layer **3** and the second recording layer **5** are both changed from the amorphous phase to the crystalline phase, the pulse generator **7** generates a fourth electric current pulse, which is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13.** The fourth electric current pulse provides a temperature (T) which satisfies $T_{x2} \leq T$ during time t which satisfies $t_{x1} \leq t$. It should be noted that Step S4 is not indispensable because Step S4 can be substituted by sequentially performing Step S1 and Step S2 or Step S2 and Step S1. Since Step S4 Is not indispensable, a transition of the state of the memory **11** which corresponds to Step S4 is represented by a broken arrow in Figure **2.**

Step S5: When the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** have the relationship $T_{m1} > T_{m2}$, and State **4** is changed to State **2**, i.e., when the phase state of the first recording layer **3** is kept at the crystalline phase while the second recording layer **5** is changed from the crystalline phase to the amorphous phase, the pulse generator **7** generates a fifth electric current pulse, which is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13.** The fifth electric current pulse provides a temperature (T) which satisfies $T_{m2} \leq T < T_{m1}$. It should be noted that Step S5 is not indispensable because Step S5 can be substituted by sequentially performing Step S3 and Step S1. Since Step S5 is not indispensable, a transition of the state of the memory **11** which corresponds to Step S5 is represented by a broken arrow in Figure **2.** Alternatively, when the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** have the relationship $T_{m1} < T_{m2}$, the fifth electric current pulse which provides a temperature (T) that satisfies $T_{m1} \leq T < T_{m2}$ is applied to the first recording layer **3** and the second recording layer **5**, whereby a transition from State **4** to State 3 can be achieved.

[0066] With Steps S1 to S3, the phase states of the first recording layer **3** and the second recording layer **5** can be changed such that one of States 1-4 is changed to another. For example, when State 2 is changed to State 1, Step S2 and Step S3 are performed. When State 3 is changed to State **1**, Step S1 and Step S3 are performed. When State 2 is changed to State 3, Step S2, Step S3, and then Step S2 are performed. When State 3 is changed to State 2, Step S1, Step S3, and then Step S1 are performed. When State **4** is changed to State 3, Step S3 and then Step S2 are performed.

[0067] When current phase states of the first recording layer **3** and the second recording layer **5** are known, the phase states of the recording layers **3** and **5** can be changed to desired phase states by a combination of the above steps. The current phase states (initial states) of the recording layers **3** and **5** can be identified by a reading method which will be described later with reference to **Figure 4.** It should be noted that, by sequentially performing Step S2 and Step S1 or Step S1 and Step S2, the phase states of the recording layers **3** and **5** are changed such that the state of the memory **11** is changed from any state to State 4. Thus-achieved State 4 may be used as the initial state for changing the phase states of the recording layers **3** and **5** to desired phase states. With such an arrangement, the reading operation can be omitted because it is not necessary to identify the current phase states of the recording layers **3** and **5.** However, the initial state of the memory **11** is not limited to State **4.**

[0068] Next, the waveform of an electric current pulse which is used to change the phase states of the recording layers **3** and **5** is described.

[0069] Figure **3** shows the waveforms of electric current pulses employed to change the phase states of the two recording layers. The pulse generator **7** shown in Figure **1** can generate electric current pulses having various pulse amplitudes (value of applied current) and various pulse widths (application time of current).

First electric current pulse **21:**

[0070] As described above with reference to Figure **2,** by applying the first electric current pulse **21** to the first recording layer **3** and the second recording layer **5,** State 1 is changed to State 2 or State 3 is changed to State 4. When

the first electric current pulse **21** is applied to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} \leq t$. In embodiment 1, the pulse amplitude I_{c1} and the pulse width t_{c1} of the first electric current pulse **21** are set to 2 mA and 150 ns, respectively. According to the present invention, the pulse amplitude I_{c1} is preferably $0.02 \leq I_{c1}(mA) \leq 10$, and the pulse width t_{x1} is preferably $5 \leq t_{x1}(ns) \leq 200$. When the first electric current pulse **21** is applied to the first recording layer **3** and the second recording layer **5**, only in the first recording layer **3**, the crystallization temperature (T_{x1}) and the crystallization time (t_{x1}) are achieved so that the first recording layer **3** changes from the amorphous phase to the crystalline phase, while a current phase state of the second recording layer **5** remains unchanged.

[0071] In this way, the first electric current pulse **21**, which provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$, is applied to the first recording layer **3** and the second recording layer **5**, whereby the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the phase state of the second recording layer **5** is kept unchanged.

Second electric current pulse **22:**

[0072] As described above with reference to Figure **2**, by applying the second electric current pulse **22** to the first recording layer **3** and the second recording layer **5**, State 1 is changed to State 3 or State 2 is changed to State 4. When the second electric current pulse **22** is applied to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$. In embodiment 1, the pulse amplitude I_{c2} and the pulse width t_{c2} of the second electric current pulse **22** are set to 4 mA and 100 ns, respectively. According to the present invention, the pulse amplitude I_{c2} is preferably $0.05 \leq I_{c2}(mA) \leq 20$, and the pulse width t_{c2} is preferably $2 \leq t_{c2}(ns) \leq 150$. When the second electric current pulse **22** is applied to the first recording layer **3** and the second recording layer **5**, only in the second recording layer **5**, the crystallization temperature (T_{x2}) and the crystallization time (t_{x2}) are achieved so that a current phase state of the first recording layer **3** remains unchanged, while the second recording layer **5** changes from the amorphous phase to the crystalline phase.

[0073] In this way, the second electric current pulse **22**, which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$, is applied to the first recording layer **3** and the second recording layer **5**, whereby the phase state of the first recording layer **3** is kept unchanged while the second recording layer **5** is changed from the amorphous phase to the crystalline phase.

Third electric current pulse **23:**

[0074] As described above with reference to Figure **2**, by applying the third electric current pulse **23** to the first recording layer **3** and the second recording layer **5**, State 4 is changed to State 1. When the third electric current pulse **23** is applied to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which is equal to or higher than the higher one of the melting points of the recording layers **3** and **5**. In embodiment 1, the pulse amplitude I_{a1} and the pulse width t_{a1} of the third electric current pulse **23** are set to 50 mA and 50 ns, respectively. According to the present invention, the pulse amplitude I_{a1} is preferably $0.1 \leq I_{a1}(mA) \leq 200$, and the pulse width t_{a1} is preferably $1 \leq t_{a1}(ns) \leq 100$. When the third electric current pulse **23** is applied to the first recording layer **3** and the second recording layer **5**, in each of the recording layers **3** and **5**, the higher one of the melting points of the recording layers **3** and **5** (in embodiment 1, T_{m1}=630°C) is achieved or exceeded so that both the recording layers **3** and **5** are melted and then quenched, and as a result, both the recording layers **3** and **5** change from the crystalline phase to the amorphous phase. The pulse amplitude of the third electric current pulse **23**, I_{a1}, is greater than the current values I_{c1} and I_{c2} which are required for changing the first recording layer **3** and the second recording layer **5** from the amorphous phase to the crystalline phase. This is in order to achieve a temperature higher than the crystallization temperatures T_{x1} and T_{x2} of the first recording layer **3** and the second recording layer **5** (i.e., T_{m1}=630°C).

[0075] In this way, the third electric current pulse **23**, which provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5**, is applied to the first recording layer **3** and the second recording layer **5**, whereby the first recording layer **3** and the second recording layer **5** are changed from the crystalline phase to the amorphous phase.

[0076] The first to third electric current pulses **21-23** are indispensable when writing information by using the writing/reading apparatus **12**. By combinations of the first to third electric current pulses **21-23**, the state of the memory **11** can be changed from any current state to any other state.

Fourth electric current pulse **24**:

[0077] As described above with reference to Figure **2**, by applying the fourth electric current pulse **24** to the first recording layer **3** and the second recording layer **5**, State 1 is changed to State **4**. When the fourth electric current pulse **24** is applied to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{c2} \leq T$ during a time (**t**) which satisfies $t_{x1} \leq t$. The pulse amplitude of the fourth electric current pulse **24**, I_{c12}, is equal to the pulse amplitude I_{c2} of the second electric current pulse **22**. The pulse width of the fourth electric current pulse **24**, t_{c12}, is equal to the pulse width t_{c1} of the first electric current pulse **21**. In embodiment 1, the pulse amplitude I_{c12} and the pulse width t_{c12} of the fourth electric current pulse **24** are set to 4 mA ($=I_{c2}$) and 150 ns ($=t_{c1}$), respectively. According to the present invention, the pulse amplitude I_{c12} is preferably $0.05 \leq I_{c12}(mA) \leq 20$, and the pulse width t_{c12} is preferably $5 \leq t_{c12}(ns) \leq 200$. When the fourth electric current pulse **24** is applied to the first recording layer **3** and the second recording layer **5**, in both the first recording layer **3** and the second recording layer **5**, the crystallization temperature T_{x2} and the crystallization time t_{x1} are achieved so that both the first recording layer **3** and the second recording layer **5** changes from the amorphous phase to the crystalline phase.

[0078] In this way, the fourth electric current pulse **24**, which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x1} \leq t$, is applied to the first recording layer **3** and the second recording layer **5**, whereby both the first recording layer **3** and the second recording layer **5** changes from the amorphous phase to the crystalline phase.

[0079] As described above, the fourth electric current pulse **24** is not indispensable because the fourth electric current pulse **24** can be substituted by application of the first electric current pulse **21** and the second electric current pulse **22**. However, the fourth electric current pulse **24** can change the state of the memory **11** from State 1 to State 4 more quickly as compared with a case where the first electric current pulse **21** and the second electric current pulse **22** (or the second electric current pulse **22** and the first electric current pulse **21**) are sequentially applied to the memory **11**.

Fifth electric current pulse **25**:

[0080] As described above with reference to Figure **2**, by applying the fifth electric current pulse **25** to the first recording layer **3** and the second recording layer **5** where the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** have the relationship $T_{m1} > T_{m2}$, State 4 is changed to State 2. When the fifth electric current pulse **25** is applied to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{m2} \leq T < T_{m1}$. In embodiment 1, the pulse amplitude I_{a2} and the pulse width t_{a2} of the fifth electric current pulse **25** are set to 30 mA and 50 ns, respectively. According to the present invention, the pulse amplitude I_{a2} is preferably $0.05 \leq I_{a2}(mA) \leq 160$, and the pulse width t_{a2} is preferably $1 \leq t_{a2}(ns) \leq 100$. When the fifth electric current pulse **25** is applied to the first recording layer **3** and the second recording layer **5**, in both the first recording layer **3** and the second recording layer **5**, the melting point of the first recording layer **3** is not reached, but the melting point of the second recording layer **5** (in embodiment 1, T_{m2}=550°C) is reached or exceeded. Accordingly, the phase state of the first recording layer **3** is kept at the crystalline phase, while only the second recording layer **5** is melted and then quenched so as to change from the crystalline phase to the amorphous phase. It should be noted that in the case where the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** have the relationship $T_{m1} < T_{m2}$, the fifth electric current pulse **25** is used to change State 4 to State 3.

[0081] In this way, in the case where the melting point T_{m1} of the first recording layer **3** and the melting point T_{m2} of the second recording layer **5** have the relationship $T_{m1} \neq T_{m2}$, the fifth electric current pulse **25**, which provides a temperature that is equal to or higher than the lower one of the melting points T_{m1} and T_{m2} and that is lower than the higher one of the melting points T_{m1} and T_{m2}, is applied to the first recording layer **3** and the second recording layer **5**, whereby one of the first recording layer **3** and the second recording layer **5** which has the lower melting point is changed from the crystalline phase to the amorphous phase, while the phase state of the other recording layer having the higher melting point is kept at the crystalline phase.

[0082] As described above, the fifth electric current pulse **25** is useful when the melting point T_{m1} of the first recording layer **3** is different from the melting point T_{m2} of the second recording layer **5**, but is not indispensable because the fifth electric current pulse **25** can be substituted by application of the third electric current pulse **23** and the first electric current pulse **21**. However, the fifth electric current pulse **25** can change the state of the memory **11** from State 4 to State 2 or State 3 more quickly as compared with a case where the third electric current pulse **23** and the first electric current pulse **21** are sequentially applied to the memory **11**.

[0083] Next, electric current pulses **26-33** which are formed by combining at least two of the first to fifth electric current pulses **21-25** are described with reference to Figure **3** in conjunction with Figure **2**.

Electric current pulse **26**:

[0084] The electric current pulse **26** is formed by combining the third electric current pulse **23** and the first electric current pulse **21**. The electric current pulse **26** can be used in place of the fifth electric current pulse **25** in order to change State **4** to State 2. By applying the electric current pulse **26** to the first recording layer **3** and the second recording layer **5**, the temperature (T) of each of the recording layers **3** and **5** is increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5**, and accordingly, the first recording layer **3** and the second recording layer **5** are melted. Thereafter, the first recording layer **3** and the second recording layer **5** are quenched so that the temperature (T) of each of the recording layers **3** and **5** is decreased so as to satisfy $T_{x1} \leq T < T_{x2}$. The electric current pulse **26** is applied during a time (t) which satisfies $t_{x1} < t$. As shown in Figure **3**, the electric current pulse **26** first exhibits the amplitude I_{a1} (in embodiment 1, I_{a1}=50 mA) and then the amplitude I_{c1} (in embodiment 1, I_{c1}=2 mA). The electric current pulse **26** has a pulse width t_{c1} in total (in embodiment 1, t_{c1}=150 ns).

[0085] As described above, the electric current pulse **26** is not indispensable because it can be substituted by the fifth electric current pulse **25**. However, the electric current pulse **26** can change the state of the memory **11** from State 4 to State 2 even if the melting point of the first recording layer 3 is equal to that of the second recording layer **5**, which cannot be achieved by the fifth electric current pulse **25**.

[0086] When the electric current pulse **26**, which first provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5** and then a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$ in total, is applied to the first recording layer **3** and the second recording layer **5**, the first recording layer **3** and the second recording layer **5** are first changed from the crystalline phase to the amorphous phase, and then, the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the second recording layer **5** is kept at the amorphous phase. That is, when the electric current pulse **26** is applied to the memory **11**, the state of the memory **11** is changed from State **4** through State 1 to State 2.

Electric current pulse **27**:

[0087] The electric current pulse **27** is formed by combining the third electric current pulse **23** and the second electric current pulse **22**. The electric current pulse **27** can be used to change State 4 to State **3**. By applying the electric current pulse **27** to the first recording layer **3** and the second recording layer **5**, the temperature (T) of each of the recording layers **3** and **5** is increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5**, and accordingly, the first recording layer **3** and the second recording layer **5** are melted. Thereafter, the first recording layer **3** and the second recording layer **5** are quenched so that the temperature (T) of each of the recording layers **3** and **5** is decreased so as to satisfy $T_{x2} \leq T$. The electric current pulse **27** is applied during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$. As shown in Figure **3**, the electric current pulse **27** first exhibits the amplitude I_{a1} and then the amplitude I_{c2} (in embodiment 1, I_{c2}=4 mA). The electric current pulse **27** has a pulse width t_{c2} in total (in embodiment 1, t_{c2}=100 ns).

[0088] When the electric current pulse **27**, which first provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5** and then a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$ in total, is applied to the first recording layer **3** and the second recording layer **5**, the first recording layer **3** and the second recording layer **5** are first changed from the crystalline phase to the amorphous phase, and then, the first recording layer **3** is kept at the amorphous phase while the second recording layer **5** is changed from the amorphous phase to the crystalline phase. That is, when the electric current pulse **27** is applied to the memory **11**, the state of the memory **11** is changed from State **4** through State 1 to State 3.

Electric current pulse **28**:

[0089] The electric current pulse **28** is formed by combining the first electric current pulse **21** and the third electric current pulse **23**. The electric current pulse **28** can be used to change State 3 to State 1. By applying the electric current pulse **28** to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} \leq t$ and then further increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5**. As shown in Figure **3**, the electric current pulse **28** first exhibits the amplitude I_{c1} with the pulse width t_{c1} and then the amplitude I_{a1} with the pulse width t_{a1} (in embodiment 1, t_{a1}=50 ns).

[0090] When the electric current pulse **28**, which first provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$ and then provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5**, is applied to the first recording layer **3** and the second recording layer **5**, the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the second recording layer **5** is kept at the crystalline phase, and then, both the first recording layer **3** and the second recording layer **5** are changed from the crystalline phase to the amorphous phase. That is, when the electric current pulse **28** is applied to the memory

11, the state of the memory **11** is changed from State 3 through State 4 to State 1.

Electric current pulse **29:**

[0091] The electric current pulse **29** is formed by combining the second electric current pulse **22** and the third electric current pulse **23.** The electric current pulse **29** can be used to change State 2 to State 1. By applying the electric current pulse **29** to the first recording layer **3** and the second recording layer **5,** the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$ and then further increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5.** As shown in Figure **3,** the electric current pulse **29** first exhibits the amplitude I_{c2} with the pulse width t_{c2} and then the amplitude I_{a1} with the pulse width t_{a1}.

[0092] When the electric current pulse **29,** which first provides a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$ and then provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5,** is applied to the first recording layer **3** and the second recording layer **5,** the first recording layer **3** is kept at the crystalline phase while the second recording layer **5** is changed from the amorphous phase to the crystalline phase, and then, both the first recording layer **3** and the second recording layer **5** are changed from the crystalline phase to the amorphous phase. That is, when the electric current pulse **29** is applied to the memory **11,** the state of the memory **11** is changed from State 2 through State 4 to State 1.

Electric current pulse **30:**

[0093] The electric current pulse **30** is formed by combining the fourth electric current pulse **24** and the third electric current pulse **23.** The electric current pulse **30** can be used to change State 2 or State **3** to State 1. The electric current pulse **30** can be used In place of the electric current pulse **28** or the electric current pulse **29.** By applying the electric current pulse **30** to the first recording layer **3** and the second recording layer **5,** the temperature of both the recording layers **3** and **5** is increased to temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x1} \leq t$ and then further increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5.** As shown in Figure **3,** the electric current pulse **30** first exhibits the amplitude I_{c2} with the pulse width t_{c1} and then the amplitude I_{a1} with the pulse width t_{a1}.

[0094] When the electric current pulse **30,** which first provides a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x1} \leq t$ and then provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5,** is applied to the first recording layer **3** and the second recording layer **5,** both the first recording layer **3** and the second recording layer **5** can be changed to the crystalline phase regardless of which phase (crystalline phase or amorphous phase) each of the recording layers **3** and **5** is in, and then, both the first recording layer **3** and the second recording layer **5** are changed from the crystalline phase to the amorphous phase. That is, when the electric current pulse **30** is applied to the memory **11,** the state of the memory 11 is changed from State 2 or State 3 through State 4 to State 1.

Electric current pulse **31:**

[0095] The electric current pulse **31** is formed by combining the second electric current pulse **22** and the electric current pulse **27** (a combination of the third electric current pulse **23** and the second electric current pulse **22**). The electric current pulse **31** can be used to change State 2 to State **3**. By applying the electric current pulse **31** to the first recording layer **3** and the second recording layer **5,** the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$. Thereafter, during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$, the temperature of both the recording layers **3** and **5** is increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5** so that the first recording layer **3** and the second recording layer **5** are melted; and then, the first recording layer **3** and the second recording layer **5** are quenched so that the temperature (T) of each of the recording layers **3** and **5** is decreased so as to satisfy $T_{x2} \leq T$. As shown in Figure **3,** the electric current pulse **31** first exhibits the amplitude I_{c2} with the pulse width t_{c2}, and then exhibits the amplitude I_{a1} plus the amplitude I_{c2} with the pulse width t_{c2}.

[0096] When the electric current pulse **31,** which first provides a temperature (T) which satisfies $T_{x2} \leq T$ during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$, and thereafter, during a time (t) which satisfies $t_{x2} \leq t < t_{x1}$, provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5** and then provides a temperature (T) which satisfies $T_{x2} \leq T$, is applied to the first recording layer **3** and the second recording layer **5,** the first recording layer **3** is kept at the crystalline phase while the second recording layer 5 is changed from the amorphous phase to the crystalline phase, and then, both the first recording layer **3** and the second recording layer **5** can be changed from the crystalline phase to the amorphous phase, and thereafter, the first recording layer **3** is kept at the

amorphous phase while the second recording layer **5** is changed from the amorphous phase to the crystalline phase. That is, when the electric current pulse **31** is applied to the memory **11**, the state of the memory **11** is changed from State 2 through State 4 and State 1 to State 3.

Electric current pulse **32**:

[0097] The electric current pulse **32** is formed by combining the first electric current pulse **21** and the fifth electric current pulse **25**. The electric current pulse **32** can be used to change State 3 to State 2. By applying the electric current pulse **32** to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (**T**) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} \leq t$ and then further increased to a temperature T_{m2}. As shown in Figure **3**, the electric current pulse **28** first exhibits the amplitude I_{c1} with the pulse width t_{c1} and then the amplitude I_{a2} (in embodiment 1, I_{a2}=30 mA) with the pulse width t_{a2} (in embodiment 1, t_{a2}=50 ns).

[0098] When the electric current pulse **32**, which first provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$ and then provides a temperature T_{m2}, is applied to the first recording layer **3** and the second recording layer **5**, the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the second recording layer **5** is kept at the crystalline phase, and then, the first recording layer **3** is kept at the crystalline phase while the second recording layer **5** is changed from the crystalline phase to the amorphous phase. That is, when the electric current pulse **32** is applied to the memory **11**, the state of the memory **11** is changed from State 3 through State 4 to State 2.

Electric current pulse **33**:

[0099] The electric current pulse **33** is formed by combining the first electric current pulse **21** and the electric current pulse **26** (a combination of the third electric current pulse **23** and the first electric current pulse **21**). The electric current pulse **33** can be used in place of the electric current pulse **32** to change State 3 to State 2. By applying the electric current pulse **33** to the first recording layer **3** and the second recording layer **5**, the temperature of both the recording layers **3** and **5** is increased to a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} \leq t$. Thereafter, during a time (t) which satisfies $t_{x1} \leq t$, the temperature of both the recording layers **3** and **5** is increased so as to reach or exceed the higher one of the melting points of the recording layers **3** and **5**; and then, the first recording layer **3** and the second recording layer **5** are quenched so that the temperature (T) of each of the recording layers **3** and **5** is decreased so as to satisfy $T_{x1} \leq T < T_{x2}$. As shown in Figure **3**, the electric current pulse **33** first exhibits the amplitude I_{c1} with the pulse width t_{c1}, and then exhibits the amplitude I_{a1} plus the amplitude I_{c1} with the pulse width t_{c1}.

[0100] When the electric current pulse **33**, which first provides a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) which satisfies $t_{x1} \leq t$, and then, during a time (t) which satisfies $t_{x1} \leq t$, provides a temperature equal to or higher than the higher one of the melting points of the recording layers **3** and **5** and thereafter provides a temperature (T) which satisfies $T_{x1} \leq T < T_{x2}$, is applied to the first recording layer **3** and the second recording layer **5**, the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the second recording layer **5** is kept at the crystalline phase, and then, both the first recording layer **3** and the second recording layer **5** are changed from the crystalline phase to the amorphous phase, and thereafter, the first recording layer **3** is changed from the amorphous phase to the crystalline phase while the second recording layer **5** is kept at the amorphous phase. That is, when the electric current pulse **33** is applied to the memory **11**, the state of the memory 11 is changed from State 3 through State 4 and State 1 to State 2.

[0101] When one of the electric current pulses **28-33** is applied to the memory **11**, the state of the memory **11** always changes to State **4** for a while before it finally reaches a desired state. Such an arrangement is adopted because, when one of the first recording layer **3** and the second recording layer **5** is in the amorphous phase (high resistive state), a large part of electric energy of an applied electric current pulse is consumed by the amorphous-phase recording layer, and in such a case, it is impossible to apply to the other crystalline phase recording layer electric energy such that the phase state of only the crystalline phase recording layer (low resistive state) can be changed to the amorphous phase. Thus, the electric current pulses **28-33** are designed such that the phase states of the both recording layers are first changed to the crystalline phase, and then changed to the amorphous phase.

[0102] The writing/reading apparatus **12** (Figure **1**) of the present invention uses three types of electric current pulses and combinations thereof to control the phase states of the first recording layer **3** and the second recording layer **5** between the crystalline phase and the amorphous phase such that the phase state of each of the recording layers **3** and **5** is changed from any phase state to a desired phase state.

[0103] Next, a method for reading information from the memory **11** is described with reference to Figure **1**. When information is read from the memory **11**, the switch **10** is closed so that the writing/reading apparatus **12** is connected to the memory **11** through the application sections **13**. The resistance measurement section **8** applies an electric current

pulse I_r to the first recording layer **3** and the second recording layer **5** and detects the resistance value of the recording layers **3** and **5** (the sum of the resistance value of the first recording layer **3** and the resistance value of the second recording layer **5**) based on a potential difference caused between the lower electrode **2** and the upper electrode **6**. The electric current pulse I_r may be generated by the pulse generator **7** in place of the resistance measurement section **8**. In this case, the switch **9** is closed. The electric current pulse I_r has an amplitude and pulse width having a size such that a phase change is not caused in the first recording layer **3** and the second recording layer **5**. The electric current pulse I_r is preferably $I_r(mA) \leq 0.02$.

[0104] Figure **4** is a flowchart illustrating the method for reading information from the memory **11** by using the writing/reading apparatus **12** of the present invention. Hereinafter, steps of the method for reading information from the memory **11** are described with reference to Figure **4** in conjunction with Figure **1**:

Step S401: The electric current pulse I_r is applied to the first recording layer **3** and the second recording layer **5** through the application sections **13.**

Step S402: The resistance measurement section **8** measures the sum of the resistance values of the first recording layer **3** and the second recording layer **5.**

Step S403: The determination section **16** determines which of States 1-4 the measured sum of the resistance values corresponds to.

Through these steps, information is read from the memory **11.**

[0105] In the examples illustrated in Figures **2** and **4,** the writing/reading apparatus **12** has both the writing function and the reading function. However, according to the present invention, the apparatus **12** may have only one of the writing (and erasing) function and the reading function. In the case where the apparatus **12** performs only a writing (and erasing) operation, the resistance measurement section **8** and the determination section **16** may be omitted from the apparatus **12.** In this case, the apparatus **12** is an apparatus for writing information in (or erasing information from) the memory **11.** In the case where the apparatus **12** performs only a reading operation, the pulse generator **7** may be omitted from the apparatus **12**. Furthermore, the switches **9** and **10** for switching between the writing (and erasing) function and the reading function may be manually operated. Alternatively, a control section for controlling the switches **9** and **10** based on a command externally supplied from the outside of the apparatus **12** may be provided.

[0106] In the example illustrated in Figure **1,** only a single memory **11** is employed. However, a memory structure including a plurality of memories **11** arranged in a matrix is within the scope of the present invention.

[0107] Figure **5** shows an exemplary structure formed by a storage device including a plurality of memories of the present invention arranged in a matrix and an external circuit connected to the storage device. Like elements are indicated by like reference numerals used in Figure **1,** and detailed descriptions thereof are omitted.

[0108] The external circuit **54** includes a pulse generator **7,** a resistance measurement section **8,** switches **9** and **10,** a determination section **16,** and a control section **51.** The storage section **58** includes application sections **13** having a row decoder and a column decoder, bit lines **52,** word lines **53,** and a memory array **55** formed by a plurality of memories **11.**

[0109] The control section **51** supplies control information indicating which of a writing operation and a reading operation is to be performed, such as a command or the like, to the pulse generator **7** and the resistance measurement section **8** through a line **56.** Based on the control information received from the control section **51,** the pulse generator **7** and the resistance measurement section **8** open or close the switches **9** and **10,** respectively, so as to perform a writing operatipn or a reading operation. Furthermore, the control section **51** supplies to the application sections **13** through a line **57** address information indicating which memory **11** in the memory array **55** an electric current pulse is to be applied.

[0110] The row decoder and the column decoder of the application sections **13** respectively select a word line **53** and a bit line **52** corresponding to a memory **11** designated by the received address information. Then, an electric current pulse is applied to the designated memory **11** so as to write information in or read information from the designated memory **11.**

[0111] A plurality of memories **11** each having a structure shown in Figure **1** may be arranged in a matrix as shown in Figure **5,** whereby the capacity of the storage device can be increased.

(Embodiment 2)

[0112] In embodiment 1, the memory **11** includes two recording layers. However, according to the present invention, the number of the recording layers included in a single memory is not limited to 2. In embodiment 2, a memory including N recording layers (N is a natural number greater than 2 (N>2)) is described.

[0113] Figure **6** shows a memory **60** including N recording layers **62**. Like elements are indicated by like reference numerals used in Figure **1**, and detailed descriptions thereof are omitted. The memory **60** includes a substrate **1**, 1st to (N-1)th intermediate layers **61**, the N recording layers **62**, and an upper electrode **6**.

[0114] The 1st to (N-1)th intermediate layers **61** are provided for the same reason as for the intermediate layer **4** of Figure **1**, i.e., provided for preventing atoms which constitute one of the N recording layers **62** from being diffusively moving therebetween. Preferably, the 1st to (N-1)th intermediate layers **61** are electrically conductive, and are made of a single metal material, such as Al, Au, Ag, Cu, Pt, Ti, W, etc., or a combination thereof (alloy material). However, the material of the intermediate layers **61** is not limited to these materials.

[0115] It should be noted that any structure for applying an electric current pulse to the N recording layers **62** can be employed in place of the lower electrode **2** and/or the upper electrode **6**. For example, if the substrate **1** is electrically conductive, the lower electrode **2** can be omitted. Furthermore, the intermediate layer **4** may be omitted when the N recording layers **62** are made of such a material that atoms constituting the N recording layers **62** do not diffusively move therebetween.

[0116] The N recording layers **62** are made of such a material that a reversible phase change between the crystalline phase and the amorphous phase is caused by increases in temperature due to application of electric energy such as an electric pulse or the like. The material of N recording layers **62** is selected such that the following conditions 1-3 are satisfied:

Condition 1: The crystallization temperature of the m-th recording layer ($1 \leq m \leq N$) among the N recording layers **62**, T_{xm}, satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$.

Condition 2: The crystallization time of the m-th recording layer ($1 \leq m \leq N$) among the N recording layers **62**, t_{xm}, satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$.

Condition 3: The resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values.

[0117] By satisfying Condition 1 and Condition 2, the phase state of each of the N recording layers **62** can be set to a desired state (amorphous phase or crystalline phase). Moreover, by satisfying Condition 3, 2^N states represented by combinations of the phase states of the N recording layers **62** can be distinguishably detected. Thus, the N recording layers **62** of the memory **60** can store 2^N-value information (N bits) corresponding to the 2^N states. In this structure, the phase state of each recording layer is controlled between the crystalline phase and the amorphous phase. This is easier than a stepwise control of the phase state of a single recording layer.

[0118] The memory **60** having such a structure can be used in place of the memory **11** shown in Figure **1**. The writing/reading apparatus **12** shown in Figure **1** can be used to write information in or read information from the memory **60**.

[0119] In the memory **60** having the above structure, each of the N recording layers **62** is in any one of the amorphous phase and the crystalline phase, whereby the state of the memory **60** can be one of the 2^N states which are expressed by combinations of the phase states of the N recording layers **62**. In embodiment 2, "State 1" means a state where all of the N recording layers **62** are in the amorphous phase. "State 2^N" means a state where all of the N recording layers **62** are in the crystalline phase. An operation which causes a transition from State 1 to any one of State 2 to State 2^N is referred to as a "write" operation. On the other hand, an operation which causes a transition from any one of State 2 to State 2^N to State 1 is referred to as "erase" operations. The phase states of each of the N recording layers **62** is changed to desired phase states, whereby information can be written in the memory **60** or information can be erased from the memory **60**.

[0120] Next, a method for writing information in the memory **60** and a method for erasing information from the memory **60** are described with reference to the writing/reading apparatus **12** shown in Figure **1** (assuming that the memory **11** shown in Figure **1** is substituted by the memory **60** of Figure **6**).

[0121] When writing information in or erasing information from the memory **60**, the switch **9** is closed and the switch **10** is opened. The pulse generator **7** generates an electric current pulse having an amplitude and width which are required to change the phase states of the N recording layers **62** to desired phase states. The electric current pulse generated by the pulse generator **7** is applied to the N recording layers **62** of the memory **60** through the application sections **13**.

[0122] Figure **7** shows the waveforms of electric current pulses employed to change the phase states of the N recording layers **62**.

Electric current pulse (crystallization pulse) **70**:

[0123] The crystallization pulse **70** is employed in order to change only the m-th recording layer ($1 \le m \le N$) from the amorphous phase to the crystalline phase. The crystallization pulse **70** is provided for each of the N recording layers **62**. When the crystallization pulse **70** is applied to the N recording layers **62**, the temperature of all the N recording layers **62** is increased to a temperature (T_x) which satisfies $T_{xm} \le T_x < T_{x(m+1)}$ during a time (t_x) which satisfies $t_{xm} \le t_x < t_{x(m-1)}$. By applying the crystallization pulse **70** having an amplitude I_{cm} and pulse width t_{cm} to the N recording layers **62**, only in the m-th recording layer, the crystallization temperature (T_{xm}) and the crystallization time (t_{xm}) are achieved so that only the m-th recording layer changes from the amorphous phase to the crystalline phase.

[0124] Thus, by applying the crystallization pulse **70**, which provides a temperature (T_x) that satisfies $T_{xm} \le T_x < T_{x(m+1)}$ during a time (t_x) that satisfies $t_{xm} \le t_x < t_{x(m-1)}$, to the N recording layers **62** through the application sections **13**, only the m-th recording layer is changed from the amorphous phase to the crystalline phase while the phase states of the other recording layers are kept unchanged. It should be noted that when m=1, the above relationship $t_{xm} \le t_x < t_{x(m-1)}$ can be expressed as $t_{x1} \le t_x$. When m=N, the above relationship $T_{xm} \le T_x < T_{x(m+1)}$ can be expressed as $T_{xN} \le T_x$.

Electric current pulse (amorphization pulse) **71**:

[0125] The amorphization pulse **71** is employed in order to change the state of the memory **60** from State 2^N to State 1. When the amorphization pulse **71** is applied to the N recording layers **62**, the temperature of all the N recording layers **62** is increased to a temperature equal to or higher than the highest one of the melting points of the N recording layers **62**. By applying such an amorphization pulse **71** having an amplitude I_{aN+1} and pulse width t_{aN+1} to the N recording layers **62**, all of the N recording layers **62** reach or exceed their melting points to be melted, and thereafter, all of the N recording layers **62** are quenched, whereby all of the N recording layers **62** are changed from the crystalline phase to the amorphous phase.

[0126] Thus, by applying the amorphization pulse **71**, which provides a temperature equal to or higher than the highest one of the melting points of the N recording layers **62**, to the N recording layers **62** through the application sections **13**, all of the N recording layers **62** can be changed from the crystalline phase to the amorphous phase.

[0127] By sequentially applying the crystallization pulses **70** for respective amorphous-phase recording layers among the N recording layers **62** to the memory **60**, any current state of the memory **60** can be changed to State 2^N. Alternatively, by applying the amorphization pulse **71** to the memory **60** which is in State 2^N, the memory **60** can be changed from State 2^N to State 1. Alternatively, when the memory **60** is in State 1, by sequentially applying to the memory **60** the crystallization pulses for one or more amorphous-phase recording layers among the N recording layers **62** which are desired to be changed from the amorphous phase to the crystalline phase, the memory **60** can be changed from State 1 to any desired state. By using the crystallization pulses **70**, the amorphization pulse **71**, or combinations thereof, the state of the memory **60** can be changed from any one of 2^N states to another.

Electric current pulse **72**:

[0128] The electric current pulse **72** is employed in order to change the m-th to (m+n-1)th recording layers ($1 \le m \le N$) among the N recording layers **62** from the amorphous phase to the crystalline phase. When the electric current pulse **72** is applied to the N recording layers **62** through the application sections **13**, the temperature of all the N recording layers **62** is increased to a temperature (T_x) which satisfies $T_{x(m+n-1)} \le T_x < T_{x(m+n)}$ during a time (t_x) which satisfies $t_{xm} \le t_x < t_{x(m-1)}$. By applying the electric current pulse **72** having an amplitude $I_{c(m+n-1)}$ and pulse width t_{cm} to the N recording layers **62**, in each of the m-th to (m+n-1)th recording layers, the crystallization temperature ($T_{x(m+n-1)}$) and the crystallization time (t_{xm}) are achieved so that all of the m-th to (m+n-1)th recording layers change from the amorphous phase to the crystalline phase.

[0129] Thus, by applying the electric current pulse **72**, which provides a temperature (T_x) that satisfies $T_{x(m+n-1)} \le T_x < T_{x(m+n)}$ during a time (t_x) that satisfies $t_{xm} \le t_x < t_{x(m-1)}$, to the N recording layers **62** through the application sections **13**, all of the m-th to (m+n-1)th recording layers among the N recording layers **62** can be changed from the amorphous phase to the crystalline phase.

[0130] The electric current pulse **72** is not indispensable because the m-th to (m+n-1)th recording layers can be changed from the amorphous phase to the crystalline phase by sequentially applying to the memory **60** the crystallization pulses **70** corresponding to the m-th to (m+n-1)th recording layers. However, the electric current pulse **72** can change the m-th to (m+n-1)th recording layers from the amorphous phase to the crystalline phase more quickly as compared with a case where the crystallization pulses **70** corresponding to the m-th to (m+n-1)th recording layers are sequentially applied to the memory **60**.

Electric current pulse **73:**

[0131] The electric current pulse **73** is employed in order to change the state of the memory **60** from State 1 to State 2^N. When the electric current pulse **73** is applied to the N recording layers **62**, the temperature of all the N recording layers **62** is increased to a temperature (T_x) which satisfies $T_{xN} \leq T_x$ during a time (t_x) which satisfies $t_{x1} \leq t_x$. By applying the electric current pulse 73 having an amplitude I_{cN} and pulse width t_{c1} to the N recording layers **62**, in all of the N recording layers **62**, the crystallization temperature (T_{xN}) and the crystallization time (t_{x1}) are achieved so that all of the N recording layers **62** change from the amorphous phase to the crystalline phase.

[0132] Thus, by applying the electric current pulse **73,** which provides a temperature (T_x) that satisfies $T_{xN} \leq T_x$ during a time (t_x) that satisfies $t_{x1} \leq t_x$, to the N recording layers **62** through the application sections **13,** all of the N recording layers **62** can be changed from the amorphous phase to the crystalline phase.

[0133] The electric current pulse **73** is not indispensable because all of the N recording layers **62** can be changed from the amorphous phase to the crystalline phase by sequentially applying to the memory **60** the crystallization pulses **70.** However, the electric current pulse **73** can change the state of the memory **60** from State 1 to State 2^N more quickly as compared with a case where the crystallization pulses **70** are sequentially applied to the memory **60.**

Electric current pulse **74:**

[0134] The electric current pulse **74** is formed by combining the electric current pulse **73** and the amorphization pulse **71.** The electric current pulse **74** is employed when at least one recording layer among the N recording layers **62** is in the amorphous phase, in order to change the state of the memory **60** to State **1.** By applying the electric current pulse **74** to the N recording layers **62,** the temperature (T) of all the N recording layers **62** is increased to a temperature (T_x) which satisfies $T_x \geq T_{xN}$ during a time (t_x) which satisfies $t_{x1} \leq t_x$ and then further increased so as to reach the highest one of the melting points of the N recording layers **62.** By applying to the N recording layers **62** the electric current pulse **74** which first exhibits the amplitude I_{cN} with the pulse width t_{c1} and then the amplitude I_{aN+1} with the pulse width t_{aN+1}, in all of the N recording layers **62,** the crystallization temperature (T_{xN}) and the crystallization time (t_{x1}) are achieved so that all of the N recording layers **62** change from the amorphous phase to the crystalline phase, and then, all of the N recording layers **62** reach or exceed the highest one of the melting points of the N recording layers **62** so that all of the N recording layers **62** are melted. Thereafter, all of the N recording layers **62** are quenched, whereby all of the N recording layers **62** are changed from the crystalline phase to the amorphous phase.

[0135] The electric current pulse **74** is not indispensable because all of the N recording layers **62** can be changed to the crystalline phase (State 2^N) by sequentially applying the crystallization pulses **70** to the memory **60,** and then, the state of the memory **60** can be changed from State 2^N to State 1 by applying the amorphization pulse **71** to the memory **60.** However, the electric current pulse **74** can change the state of the memory **60** from any state except for State 2^N to State 1 more quickly as compared with a case where the crystallization pulses **70** for the first to Nth recording layers and the amorphization pulse **71** are sequentially applied to the memory **60.**

Electric current pulse **75:**

[0136] The electric current pulse **75** is employed in the case where each of one or more recording layers among the N recording layers **62** has a melting point equal to or lower than a temperature T_m, and each of the other recording layers among the N recording layers **62** has a melting point higher than a temperature T_m, in order to change the one or more recording layers from the crystalline phase to the amorphous phase while the other recording layer are kept at the crystalline phase. By applying the electric current pulse **75** to the N recording layers **62,** the temperature (T) of all the N recording layers **62** is increased so that each of the one or more recording layers reaches the temperature T_m. By applying to the N recording layers **62** the electric current pulse **75** having the amplitude I_{am} and the pulse width t_{am}, each of the one or more recording layers which have melting points equal to or lower than the temperature T_m reaches the temperature T_m so as to change from the crystalline phase to the amorphous phase.

[0137] The temperature T_m may be any temperature which is equal to or higher than the lowest one of the melting points of the N recording layers **62** and lower than the highest one of the melting points of the N recording layers **62.** By determining the temperature T_m, the N recording layers **62** can be divided into a group consisting of one or more recording layers each of which has a melting point equal to or lower than the temperature T_m and a group consisting of the other recording layers each of which has a melting point higher than the temperature T_m. By applying to the N recording layers **62** the electric current pulse **75** which provides the temperature T_m, each of the recording layers having a melting point equal to or lower than the temperature T_m can be changed from the crystalline phase to the amorphous phase.

[0138] The electric current pulse **75** is useful when the melting points of the N recording layers **62** are different, but not indispensable because only a desired recording layer(s) among the N recording layers **62** can be changed to the

crystalline phase by sequentially applying the amorphization pulse **71** and the crystallization pulses **70** to the memory **60** in place of the electric current pulse **75**. However, the electric current pulse **75** can change only a desired recording layer(s) among the N recording layers **62** to the crystalline phase more quickly as compared with a case where the amorphization pulse **71** and the crystallization pulses **70** are sequentially applied to the memory **60**.

[0139] When current phase states of the N recording layers **62** are known, the phase states of the N recording layers **62** can be changed to desired phase states by a combination of the crystallization pulses **70** and the amorphization pulse **71**. The current phase states (initial states) of the N recording layers **62** can be identified by a reading method which will be described later with reference to Figure **8**. It should be noted that, by sequentially applying to the memory **60** the crystallization pulses **70** corresponding to the respective one of the first to Nth recording layers (or by applying the electric current pulse **73** to the memory **60**), the state of the memory **60** is changed from any state to State 2^N. Thus-achieved State 2^N may be used as the initial state for changing the phase states of the N recording layers **62** to desired phase states. With such an arrangement, the reading operation can be omitted because it is not necessary to identify the current phase states of the N recording layers **62**. However, the initial state of the memory **60** is not limited to State 2^N.

[0140] Next, a method for reading information from the memory 60 is described with reference to the writing/reading apparatus **12** of Figure **1** (assuming that the memory **11** shown in Figure **1** is substituted by the memory **60** of Figure **6**). The reading method of embodiment 2 is substantially the same as that of embodiment 1 which has been described with reference to Figure **4**. When information is read from the memory **60**, the switch **10** is closed so that the writing/reading apparatus **12** is connected to the memory **60** through the application sections **13**. The resistance measurement section **8** applies an electric current pulse I_r to the N recording layers **62** and detects the resistance value of the N recording layers **62** (the sum of the resistance values of each of the N recording layers **62**) based on a potential difference caused between the lower electrode **2** and the upper electrode **6**. The electric current pulse I_r has an amplitude and pulse width having a size such that a phase change is not caused in the N recording layers **62**.

[0141] Figure **8** is a flowchart illustrating the method for reading information from the memory **60** by using the writing/reading apparatus **12** of the present invention. Hereinafter, steps of the method for reading information from the memory **60** are described with reference to Figure **8** in conjunction with Figure **1**:

Step S801: The < electric current pulse I_r is applied to the N recording layers **62** through the application sections **13**.

Step S802: The resistance measurement section **8** measures the sum of the resistance values of the N recording layers **62**.

Step S803: The determination section **16** determines which of States 1-2^N the measured sum of the resistance values corresponds to.

Through these steps, information is read from the memory **60**.

[0142] It should be noted that a plurality of memories **60** each having a structure shown in Figure **6** may be arranged in a matrix as shown in Figure **5**, whereby the capacity of a storage device can be increased.

[0143] In the memory **60** of Figure **6**, the recording layers **62** are formed in the order from the first recording layer to the Nth recording layer. However, the first to Nth recording layers may be formed in any other order (e.g., in a random order).

[0144] A memory of the present invention includes a first recording layer and a second recording layer each of which records information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which may occur due to increases in temperature caused by the application of the electric current pulse. The crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$, and the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, such that each of the first and second recording layers can be set at a desired phase state (amorphous phase or crystalline phase). Furthermore, where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another. Thus, four states of the memory represented by combinations of the phase state of the first recording layer and the phase state of the second recording layer can be distinguishably detected. In this structure, the phase state of each recording layer is controlled between the crystalline phase and the amorphous phase. This is easier than a stepwise control of the phase state of a single recording layer. The number of recording layers is not limited to 2. The same effects of the present invention can be obtained even with a memory including more than two recording layers.

[0145] Various other modifications will be apparent to and can be readily made by those skilled in the art without

departing from the scope and spirit of this invention. Accordingly, it is not intended that the scope of the claims appended hereto be limited to the description as set forth herein, but rather that the claims be broadly construed.

Claims

1. A memory, comprising:

   a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and
   a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
   wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$,
   the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and
   $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}.

2. A memory according to claim 1, wherein the melting point of the first recording layer, T_{m1}, satisfies the relationship $400 \leq T_{m1}(°C) \leq 800$.

3. A memory according to claim 1, wherein the melting point of the second recording layer, T_{m2}, satisfies the relationship $300 \leq T_{m2}(°C) \leq 700$.

4. A memory according to claim 1, wherein the crystallization temperature of the first recording layer, T_{x1}, satisfies the relationship $130 \leq T_{x1}(°C) \leq 230$.

5. A memory according to claim 1, wherein the crystallization temperature of the second recording layer, T_{x2}, satisfies the relationship $160 \leq T_{x2}(°C) \leq 260$.

6. A memory according to claim 1, wherein the crystallization time of the first recording layer, t_{x1}, satisfies the relationship $5 \leq t_{x1}(ns) \leq 200$.

7. A memory according to claim 1, wherein the crystallization time of the second recording layer, t_{x2}, satisfies the relationship $2 \leq t_{x2}(ns) \leq 150$.

8. A memory according to claim 1, wherein:

   the first recording layer includes three elements, Ge, Sb, and Te; and
   the second recording layer includes (Sb-Te)-M1, where M1 is at least one selected from a group consisting of Ag, In, Ge, Sn, Se, Bi, Au, and Mn.

9. A memory according to claim 1, wherein the first recording layer is formed on a substrate, and the upper electrode is formed on the second recording layer.

10. A memory according to claim 9, wherein a lower electrode is formed between the substrate and the first recording layer.

11. A memory according to claim 1, wherein an intermediate layer is formed between the first recording layer and the second recording layer.

12. A memory according to claim 1, wherein the specific resistance r_{a1} of the first recording layer in the amorphous phase is $1.0 \leq r_{a1}(\Omega \cdot cm) \leq 1 \times 10^{7}$.

13. A memory according to claim 1, wherein the specific resistance r_{a2} of the second recording layer in the amorphous phase is $2.0 \leq r_{a2}(\Omega \cdot cm) \leq 2 \times 10^7$.

14. A memory according to claim 1, wherein the specific resistance r_{c1} of the first recording layer in the crystalline phase is $1 \times 10^{-3} \leq r_{c1}(\Omega \cdot cm) \leq 1.0$.

15. A memory according to claim 1, wherein the specific resistance r_{c2} of the second recording layer in the crystalline phase is $1 \times 10^{-3} \leq r_{c2}(\Omega \cdot cm) \leq 1.0$.

16. A writing apparatus for writing information in a memory, the memory including:

a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and
a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$,
the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and
$R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and
the writing apparatus including:

a pulse generator for generating at least first to third electric current pulses; and
an application section through which the at least first to third electric current pulses are applied to the first recording layer and the second recording layer,

wherein in order to change the first recording layer from the amorphous phase to the crystalline phase while the phase state of the second recording layer is kept unchanged, the pulse generator generates the first electric current pulse which provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$, in order to change the second recording layer from the amorphous phase to the crystalline phase while the phase state of the first recording layer is kept unchanged, the pulse generator generates the second electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$, and
in order to change both the first recording layer and the second recording layer from the crystalline phase to the amorphous phase, the pulse generator generates the third electric current pulse which provides a temperature equal to or higher than the higher one of the melting points of the first and second recording layers.

17. A writing apparatus according to claim 16, wherein the pulse amplitude of the first electric current pulse, I_{c1}, is $0.02 \leq I_{c1}(mA) \leq 10$, and the pulse width of the first electric current pulse, t_{c1}, is $5 \leq t_{c1}(ns) \leq 200$.

18. A writing apparatus according to claim 16, wherein the pulse amplitude of the second electric current pulse, I_{c2}, is $0.05 \leq I_{c2}(mA) \leq 20$, and the pulse width of the second electric current pulse, t_{c2}, is $2 \leq t_{c2}(ns) \leq 150$.

19. A writing apparatus according to claim 16, wherein the pulse amplitude of the third electric current pulse, I_{a1}, is $0.1 \leq I_{a1}(mA) \leq 200$, and the pulse width of the third electric current pulse, t_{a1}, is $1 \leq t_{a1}(ns) \leq 100$.

20. A writing apparatus according to claim 16, wherein, in order to change both the first recording layer and the second recording layer from the amorphous phase to the crystalline. phase, the pulse generator generates a fourth electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x1} \leq t$.

21. A writing apparatus according to claim 20, wherein the pulse amplitude of the fourth electric current pulse, I_{c12}, is $0.05 \leq I_{c12}(mA) \leq 20$, and the pulse width of the fourth electric current pulse, t_{c12}, is $5 \leq t_{c12}(ns) \leq 200$.

22. A writing apparatus according to claim 16, wherein, when the melting point of the first recording layer, T_{m1}, and the melting point of the second recording layer, T_{m2}, have the relationship $T_{m1} \neq T_{m2}$, in order to change the recording layer having the lower one of the melting points T_{m1} and T_{m2} from the crystalline phase to the amorphous phase while the phase state of the recording layer having the higher one of the melting points T_{m1} and T_{m2} is kept at the crystalline phase, the pulse generator generates a fifth electric current pulse which provides a temperature equal to or higher than the lower one of the melting points T_{m1} and T_{m2} and lower then the higher one of the melting points T_{m1} and T_{m2}.

23. A writing apparatus according to claim 22, wherein the pulse amplitude of the fifth electric current pulse, I_{a2}, is $0.05 \leq I_{a2}(mA) \leq 160$, and the pulse width of the fifth electric current pulse, t_{a2}, is $1 \leq t_{a2}(ns) \leq 100$.

24. A reading apparatus for reading information from a memory, the memory including:

a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and
a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$,
the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and
$R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and
the reading apparatus including:

an application section through which an electric current pulse is applied to the first and second recording layers;
a resistance measurement device for measuring a sum of the resistances of the first and second recording layers; and
a determination section for determining which of the four different sums of resistance values, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$, the measured sum of the resistance values of the first and second recording layers is equal to.

25. A reading apparatus according to claim 24, wherein the electric current pulse has an amplitude I_r having a size such that a phase change is not caused in the first and second recording layers.

26. A reading apparatus according to claim 25, wherein the amplitude I_r of the electric current pulse is $I_r(mA) \leq 0.02$.

27. A memory, comprising
N recording layers (N is a natural number which satisfies $N > 2$) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < \ldots < T_{xm-1} < T_{xm} < T_{xm+1} < \ldots < T_{xN}$,
the crystallization time t_{xm} of the m-th recording layer satisfies the relationshlp $t_{x1} > t_{x2} > \ldots > t_{xm-1} > t_{xm} > t_{xm+1} > \ldots > t_{xN}$, and
the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values.

28. A writing apparatus for writing information in a memory, the memory including
N recording layers (N is a natural number which satisfies $N > 2$) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,

wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$,

the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and

the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and

the writing apparatus including:

a pulse generator for generating at least N crystallization pulses and amorphization pulse, and

an application section through which the at least N crystallization pulses and amorphization pulse are applied to the N recording layers,

wherein in order to change only the m-th recording layer from the amorphous phase to the crystalline phase while the phase states of the other recording layers are kept unchanged, the pulse generator generates a crystallization pulse which provides a temperature (T) that satisfies $T_{xm} \leq T_x < T_{x(m+1)}$ during a time (t) that satisfies $t_{xm} \leq t_x < t_{x(m-1)}$, and

in order to change all of the N recording layers from the crystalline phase to the amorphous phase, the pulse generator generates the amorphization pulse which provides a temperature equal to or higher than the highest one of the melting points of the N recording layers.

29. A writing apparatus according to claim 28, wherein, in order to change all of the N recording layers from the amorphous phase to the crystalline phase, the pulse generator generates an electric current pulse which provides a temperature (T) that satisfies $T_{xN} \leq T_x$ during a time (t) that satisfies $t_{x1} \leq t_x$.

30. A writing apparatus according to claim 28, wherein, in order to change the m-th to (m+n-1)th recording layers among the N recording layers from the amorphous phase to the crystalline phase, the pulse generator generates an electric current pulse which provides a temperature (T) that satisfies $T_{x(m+n-1)} \leq T_x < T_{x(m+n)}$ during a time (t) that satisfies $t_{xm} \leq t_x < t_{x(m-1)}$.

31. A writing apparatus according to claim 28, wherein, when each of one or more recording layers among the N recording layers has a melting point equal to or lower than a temperature T_m, and each of the other recording layers among the N recording layers has a melting point higher than the temperature T_m, in order to change the one or more recording layers from the crystalline phase to the amorphous phase while the other recording layers are kept at the crystalline phase, the pulse generator generates an electric current pulse which produces the temperature T_m.

32. A reading apparatus for reading information from a memory, the memory including

N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,

wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$,

the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and

the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and

the reading apparatus including:

an application section through which an electric current pulse is applied to the N recording layers;

a resistance measurement device for measuring a sum of the resistances of the N recording layers; and

a determination section for determining which of the 2^N different values for the sum of resistance values the measured sum of the resistance values of the N recording layers is equal to.

33. A method for writing information in a memory, the memory including:

a first recording layer for recording information by utilizing a reversible phase change between a crystalline

phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and
a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$,
the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and
$R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and
the writing method including steps of:

generating at least first to third electric current pulses: and
applying the at least first to third electric current pulses to the first recording layer and the second recording layer,

wherein, in the step of generating the at least first to third electric current pulses, in order to change the first recording layer from the amorphous phase to the crystalline phase while the phase state of the second recording layer is kept unchanged, the pulse generator generates the first electric current pulse which provides a temperature (T) that satisfies $T_{x1} \leq T < T_{x2}$ during a time (t) that satisfies $t_{x1} \leq t$,
in order to change the second recording layer from the amorphous phase to the crystalline phase while the phase state of the first recording layer is kept unchanged, the pulse generator generates the second electric current pulse which provides a temperature (T) that satisfies $T_{x2} \leq T$ during a time (t) that satisfies $t_{x2} \leq t < t_{x1}$, and
in order to change both the first recording layer and the second recording layer from the crystalline phase to the amorphous phase, the pulse generator generates the third electric current pulse which provides a temperature equal to or higher than the higher one of the melting points of the first and second recording layers.

34. A method for reading information from a memory, the memory including:

a first recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse; and
a second recording layer for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,
wherein the crystallization temperature of the first recording layer, T_{x1}, and the crystallization temperature of the second recording layer, T_{x2}, have the relationship $T_{x1} < T_{x2}$,
the crystallization time of the first recording layer, t_{x1}, and the crystallization time of the second recording layer, t_{x2}, have the relationship $t_{x1} > t_{x2}$, and
$R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}, and
the reading method including steps of:

applying an electric current pulse to the first recording layer and the second recording layer;
measuring a sum of the resistances of the first and second recording layers; and
determining which of the four different sums of resistance values, $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$, the measured sum of the resistance values of the first and second recording layers is equal to.

35. A method for writing information in a memory, the memory including
N recording layers (N is a natural number which satisfies $N > 2$) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,

wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$,

the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and

the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and

the writing method including steps of:

generating at least N crystallization pulses and amorphization pulse, and

applying the at least N crystallization pulses and amorphization pulse to the N recording layers,

wherein, in the step of generating the first to (N+1)th electric current pulses, in order to change only the m-th recording layer from the amorphous phase to the crystalline phase while the phase states of the other recording layers are kept unchanged, the pulse generator generates a crystallization pulse which provides a temperature (T) that satisfies $T_{xm} \leq T_x < T_{x(m+1)}$ during a time (t) that satisfies $t_{xm} \leq t_x < t_{x(m-1)}$, and

in order to change all of the N recording layers from the crystalline phase to the amorphous phase, the pulse generator generates the amorphization pulse which provides a temperature equal to or higher than the highest one of the melting points of the N recording layers.

36. A method for reading information from a memory, the memory including

N recording layers (N is a natural number which satisfies N > 2) for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse,

wherein the crystallization temperature T_{xm} of the m-th recording layer ($1 \leq m \leq N$) satisfies the relationship $T_{x1} < T_{x2} < ... < T_{xm-1} < T_{xm} < T_{xm+1} < ... < T_{xN}$,

the crystallization time t_{xm} of the m-th recording layer satisfies the relationship $t_{x1} > t_{x2} > ... > t_{xm-1} > t_{xm} > t_{xm+1} > ... > t_{xN}$, and

the resistance values of the N recording layers in the amorphous phase are different from one another, the resistance values of the N recording layers in the crystalline phase are different from one another, and the sum of the resistance values of the N recording layers is one of 2^N values, and

the reading method including steps of:

applying an electric current pulse to the N recording layers;

measuring a sum of the resistances of the N recording layers; and

determining which of the 2^N different values for the sum of resistance values the measured sum of the resistance values of the N recording layers is equal to.

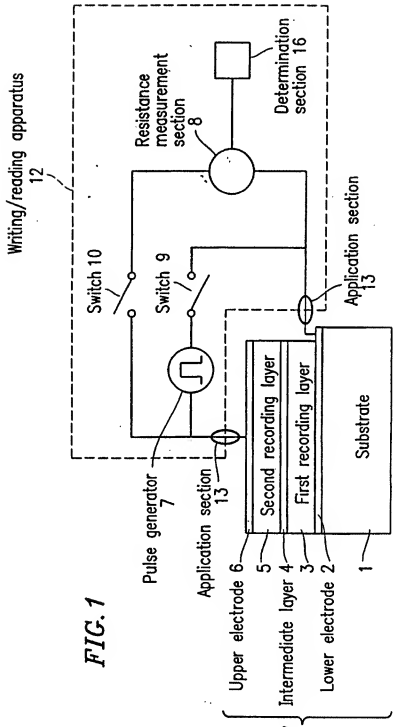

Writing/reading apparatus
12
Switch 10
Switch 9
Resistance measurement section
8
Determination section 16
Application section
13
Pulse generator
7
Application section
13
Second recording layer
First recording layer
Substrate
Upper electrode 6
5
Intermediate layer 4
3
Lower electrode 2
1
Memory
11

FIG. 1

FIG. 2

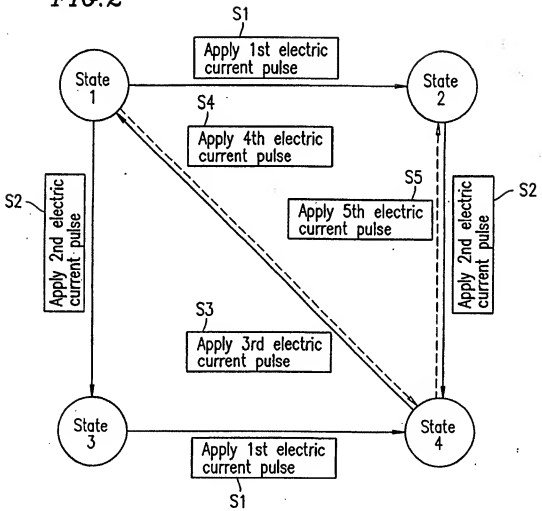

S1
Apply 1st electric current pulse
State 1
State 2
S4
Apply 4th electric current pulse
S5
Apply 5th electric current pulse
S2
Apply 2nd electric current pulse
S2
Apply 2nd electric current pulse
S3
Apply 3rd electric current pulse
State 3
State 4
Apply 1st electric current pulse
S1

FIG. 3

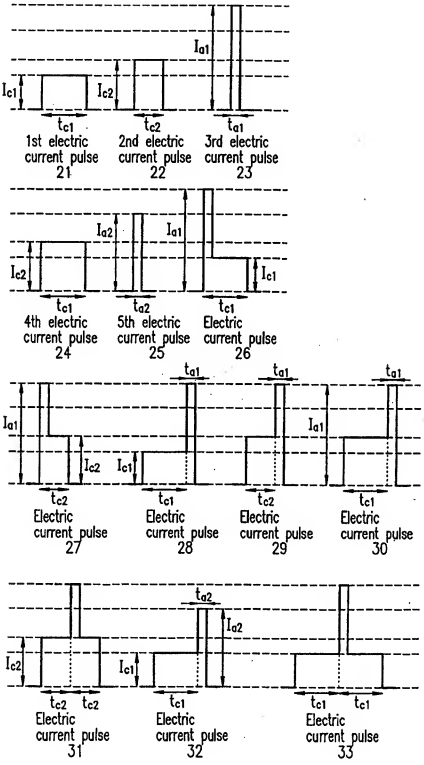

Ia1
Ic1
Ic2
tc1
tc2
ta1
1st electric current pulse 21
2nd electric current pulse 22
3rd electric current pulse 23
Ia2
Ia1
Ic2
Ic1
tc1
ta2
ta1
4th electric current pulse 24
5th electric current pulse 25
Electric current pulse 26
ta1
ta1
ta1
Ia1
Ia1
Ic2
Ic1
tc2
tc1
tc2
tc1
Electric current pulse 27
Electric current pulse 28
Electric current pulse 29
Electric current pulse 30
ta2
Ia2
Ic2
Ic1
tc2
tc2
tc1
tc1
tc1
Electric current pulse 31
Electric current pulse 32
Electric current pulse 33

FIG. 4

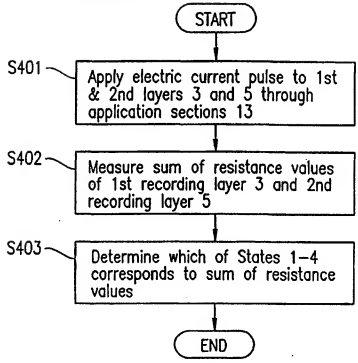

START
S401
Apply electric current pulse to 1st & 2nd layers 3 and 5 through application sections 13
S402
Measure sum of resistance values of 1st recording layer 3 and 2nd recording layer 5
S403
Determine which of States 1–4 corresponds to sum of resistance values
END

FIG. 5

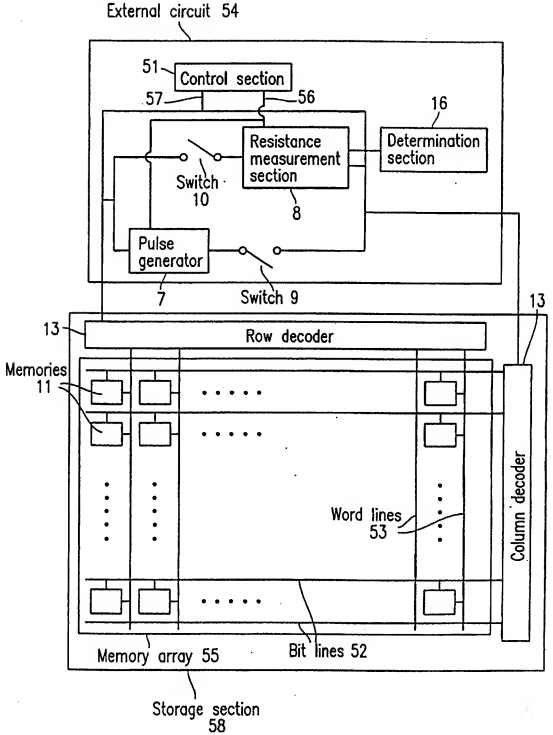

External circuit 54
51
Control section
57
56
16
Resistance measurement section
Determination section
Switch 10
8
Pulse generator
7
Switch 9
13
13
Row decoder
Memories 11
Word lines 53
Column decoder
Memory array 55
Bit lines 52
Storage section 58

FIG. 6

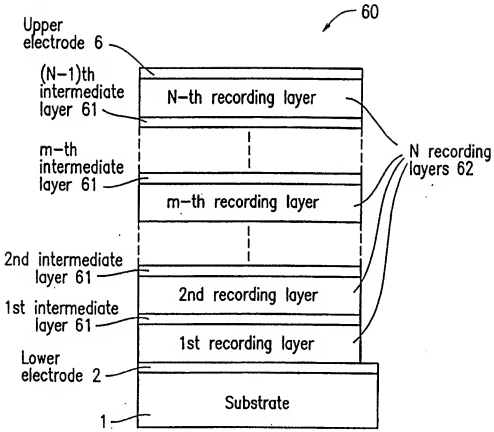

60
Upper electrode 6
(N−1)th intermediate layer 61
N−th recording layer
N recording layers 62
m−th intermediate layer 61
m−th recording layer
2nd intermediate layer 61
2nd recording layer
1st intermediate layer 61
1st recording layer
Lower electrode 2
Substrate
1

FIG. 7

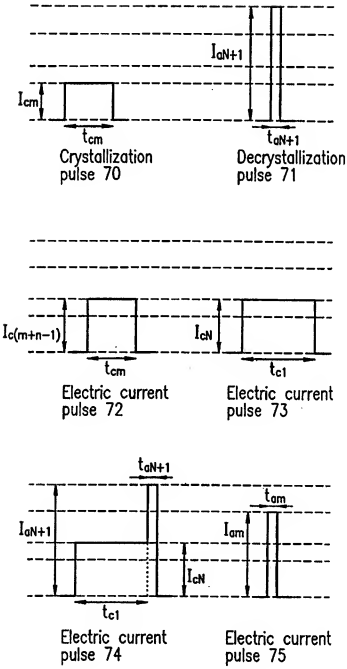
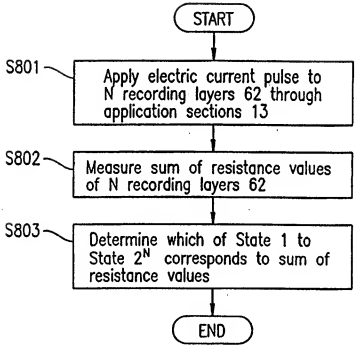

I_{aN+1}
I_{cm}
t_{cm}
t_{aN+1}
Crystallization pulse 70
Decrystallization pulse 71
$I_{c(m+n-1)}$
I_{cN}
t_{cm}
t_{c1}
Electric current pulse 72
Electric current pulse 73
t_{aN+1}
t_{am}
I_{aN+1}
I_{am}
I_{cN}
t_{c1}
Electric current pulse 74
Electric current pulse 75

FIG. 8


START
S801
Apply electric current pulse to N recording layers 62 through application sections 13
S802
Measure sum of resistance values of N recording layers 62
S803
Determine which of State 1 to State 2^N corresponds to sum of resistance values
END

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(54) **Memory, writing apparatus, reading apparatus, writing method, and reading method**

(57) A memory includes: first and second recording layers for recording information by utilizing a reversible phase change between a crystalline phase and an amorphous phase which occurs due to increases in temperature caused by application of an electric current pulse. The crystallization temperatures of the first and second recording layers, T_{x1} and T_{x2}, have the relationship $T_{x1} < T_{x2}$. The crystallization times of the first and second recording layers, t_{x1} and t_{x2}, have the relationship $t_{x1} > t_{x2}$. $R_{a1}+R_{a2}$, $R_{a1}+R_{c2}$, $R_{c1}+R_{a2}$, and $R_{c1}+R_{c2}$ are different from one another where the resistance value of the first recording layer in the amorphous phase is R_{a1}, the resistance value of the first recording layer in the crystalline phase is R_{c1}, the resistance value of the second recording layer in the amorphous phase is R_{a2}, and the resistance value of the second recording layer in the crystalline phase is R_{c2}.

EP 1 202 285 A3

European Patent Office

EUROPEAN SEARCH REPORT

Application Number
EP 01 12 5119

DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
A	PATENT ABSTRACTS OF JAPAN vol. 010, no. 009 (P-420), 14 January 1986 (1986-01-14) & JP 60 164937 A (HITACHI SEISAKUSHO KK), 28 August 1985 (1985-08-28) * abstract * ---	1-36	G11C11/34
A	EP 0 449 121 A (FUJI PHOTO FILM CO LTD) 2 October 1991 (1991-10-02) * column 4, line 12-24; figure 1 * ---	1-36	
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A	US 5 296 716 A (HUDGENS STEPHEN J ET AL) 22 March 1994 (1994-03-22) * column 5, line 63 - column 6, line 11 * * column 15, line 38-63; figure 1 * -----	1-36	

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G11C

The present search report has been drawn up for all claims

Place of search	Date of completion of the search	Examiner
MUNICH	29 October 2003	Gaertner, W

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